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[®]Title: CN1381904A: PACKAGE OF LED CHIP AND ITS LIGHT-GATHERING LENS

ਊCountry: CN China

& Kind: A Unexamined APPLIC. open to Public inspection!

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A LED chip package is composed of a PCB substrate with a conductor layer and an electrode on its one surface, a LED chip on the said conductor layer and connected with the said electrode via a wire, and a light gathering lens of strut shape with internal concave surface and external convex surface corresponding to the position of LED chip and connected to PC substrate.

Family: Buy Publication Pub. Date Filed Title

CN1381904A 2002-11-27 2001-04-18 PACKAGE OF LED CHIP AND ITS LIGHT-GATHE LENS

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